

September 2015

# **KSC1009 NPN Epitaxial Silicon Transistor**

#### **Features**

- High Voltage Amplifier
- High Collector-Base Voltage : V<sub>CBO</sub> = 160 V
- Collector Current : I<sub>C</sub> = 700 mA
- Collector Power Dissipation : P<sub>C</sub> = 800 mW
- Complement to KSA709
- Suffix "-C" means Center Collector (1. Emitter 2. Collector 3. Base)
- Non Suffix "-C" means Side Collector (1. Emitter 2. Base 3. Collector)



## **Ordering Information**

Part Number	Top Mark	Package	Packing Method
KSC1009YTA	KSC1009YTA C1009 Y-		Ammo

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	160	V
V <sub>CEO</sub>	Collector-Emitter Voltage	140	V
V <sub>EBO</sub>	Emitter-Base Voltage	8	V
I <sub>C</sub>	Collector Current	700	mA
T <sub>J</sub> Junction Temperature		150	°C
T <sub>STG</sub> Storage Temperature		-55 to 150	°C

## Thermal Characteristics(1)

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
P <sub>C</sub>	Collector Power Dissipation	800	mW
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	150	°C/W

#### Note:

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \mu\text{A}, I_E = 0$	160			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = 10 \text{ mA}, I_B = 0$	140			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	8			V
I <sub>CBO</sub>	Collector Cut-Off Current	$V_{CB} = 60 \text{ V}, I_{E} = 0$			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-Off Current	$V_{EB} = 5 \text{ V}, I_{C} = 0$			0.1	μΑ
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 2 \text{ V}, I_{C} = 50 \text{ mA}$	40		400	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 200 \text{ mA}, I_B = 20 \text{ mA}$		0.2	0.7	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 200 \text{ mA}, I_B = 20 \text{ mA}$		0.86	1.00	V
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE} = 10 \text{ V}, I_{C} = 50 \text{ mA}$	30	50		MHz
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 10 \text{ V}, I_{E} = 0,$ f = 1 MHz		8		pF

## h<sub>FE</sub> Classification

Classification R		0	Y	G
h <sub>FE</sub>	40 ~ 80	70 ~ 140	120 ~ 240	200 ~ 400

## **Typical Performance Characteristics**

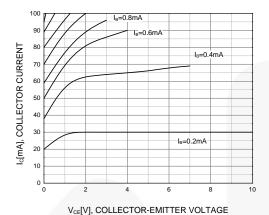


Figure 1. Static Characteristic

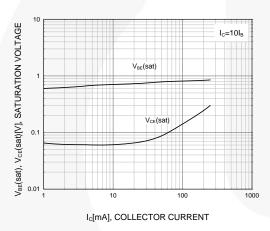


Figure 3. Base-Emitter Saturation Voltage and Collector-Emitter Saturation Voltage

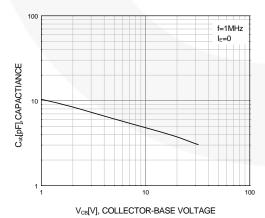


Figure 5. Collector Output Capacitance

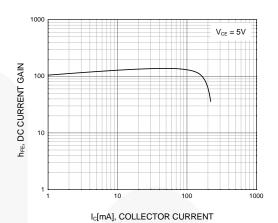


Figure 2. DC Current Gain

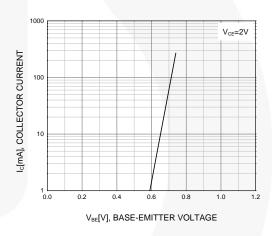
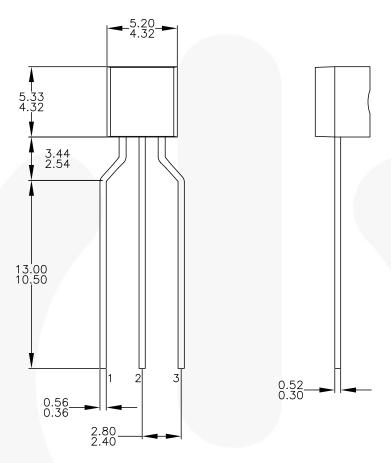
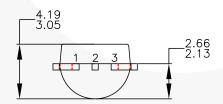


Figure 4. Base-Emitter On Voltage

## **Physical Dimensions**





NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC. ALL DIMENSIONS ARE IN MILLIMETERS. DRAWING CONFORMS TO ASME Y14.5M-2009. DRAWING FILENAME: MKT-ZAO3FREV3. FAIRCHILD SEMICONDUCTOR.

Figure 6. 3-Lead, TO-92, Molded, 0.2 In Line Spacing Lead Form, Ammo Type





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Definition of Terms				
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